RoHS
Available on commercial versions

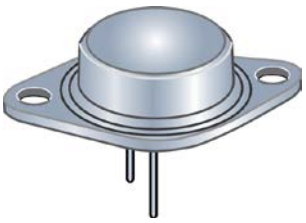
PNP Darlington Power Silicon Transistor

Qualified per MIL-PRF-19500/505

Qualified Levels:
JAN, JANTX, and JANTXV

DESCRIPTION

This high speed PNP transistor is rated at 20 amps and is military qualified up to a JANTXV level. This TO-204AA isolated package features a 180 degree lead orientation.



TO-204AA (TO-3) Package

Important: For the latest information, visit our website http://www.microsemi.com.

FEATURES

- JEDEC registered 2N6286 and 2N6287
- JAN, JANTX, and JANTXV qualifications are available per MIL-PRF-19500/505
- RoHS compliant versions available (commercial grade only)

APPLICATIONS / BENEFITS

- Military, space and other high reliability applications
- High frequency response
- TO-204AA case with isolated terminals

MAXIMUM RATINGS @ T_C = +25 °C unless otherwise noted

Parameters/Test Conditions		Symbol	Value	Unit
Junction and Storage Temperature		T_J and T_{STG}	-65 to +175	°C
Thermal Resistance Junction-to-Case		$R_{\Theta JC}$	0.855	°C/W
Collector Current		I_C	-20	A
Collector-Emitter Voltage	2N6286 2N6287	V_{CEO}	-80 -100	V
Collector-Base Voltage	2N6286 2N6287	V_{CBO}	-80 -100	V
Emitter-Base Voltage		V_{EBO}	-7	V
Total Power Dissipation	@ T_C = +25 °C (1) @ T_C = +100 °C	P_T	175 87.5	W

Notes: 1. Derate linearly 1.0 W/°C above T_C > +25 °C

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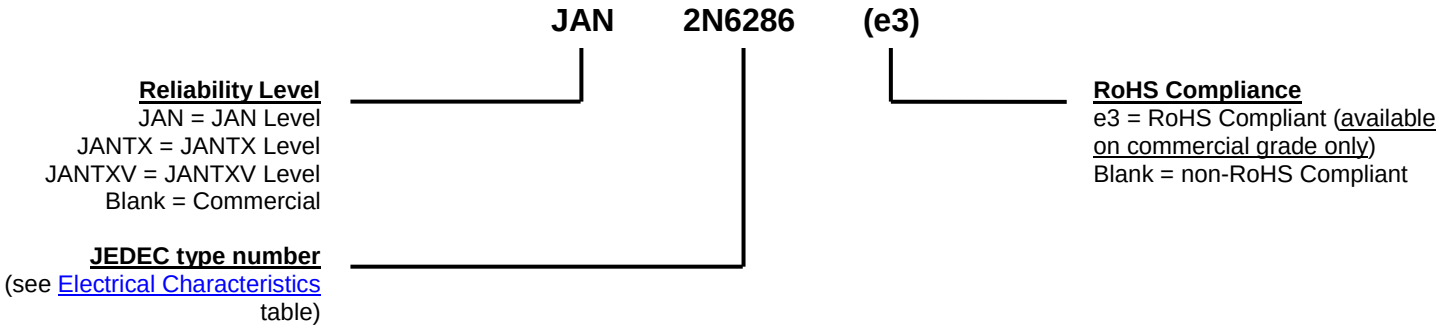
MECHANICAL and PACKAGING

- CASE: Industry standard TO-204AA (TO-3), hermetically sealed, 0.040 inch diameter pins
- FINISH: Solder dipped tin-lead over nickel plated alloy 52 or RoHS compliant matte-tin plating. Solderable per MIL-STD-750 method 2026.
- POLARITY: PNP (see schematic)
- MOUNTING HARDWARE: Consult factory for optional insulator and sheet metal screws
- WEIGHT: Approximately 15 grams
- See package dimensions on last page.

PART NOMENCLATURE



SYMBOLS & DEFINITIONS

Symbol	Definition
I_B	Base current: The value of the dc current into the base terminal.
I_C	Collector current: The value of the dc current into the collector terminal.
I_E	Emitter current: The value of the dc current into the emitter terminal.
T_C	Case temperature: The temperature measured at a specified location on the case of a device.
V_{CB}	Collector-base voltage: The dc voltage between the collector and the base.
V_{CBO}	Collector-base voltage, base open: The voltage between the collector and base terminals when the emitter terminal is open-circuited.
V_{CC}	Collector-supply voltage: The supply voltage applied to a circuit connected to the collector.
V_{CEO}	Collector-emitter voltage, base open: The voltage between the collector and the emitter terminals when the base terminal is open-circuited.
V_{EB}	Emitter-base voltage: The dc voltage between the emitter and the base.
V_{EBO}	Emitter-base voltage, collector open: The voltage between the emitter and base terminals with the collector terminal open-circuited.

ELECTRICAL CHARACTERISTICS @ T_A = +25 °C unless otherwise noted

Characteristics		Symbol	Min.	Max.	Unit
OFF CHARACTERISTICS					
Collector-Emitter Breakdown Voltage I_C = -100 mA	2N6286 2N6287	$V_{(BR)CEO}$	-80 -100		V
Collector-Emitter Cutoff Current V_{CE} = -40 V V_{CE} = -50 V	2N6286 2N6287	I_{CEO}		-1.0 -1.0	mA
Collector-Emitter Cutoff Current V_{CE} = -80 V, V_{BE} = +1.5 V V_{CE} = -100 V, V_{BE} = +1.5 V	2N6286 2N6287	I_{CEX}		10 10	µA
Emitter-Base Cutoff Current V_{EB} = -7.0 V		I_{EBO}		-2.5	mA
ON CHARACTERISTICS					
Forward-Current Transfer Ratio I_C = -1.0 A, V_{CE} = -3.0 V I_C = -10 A, V_{CE} = -3.0 V I_C = -20 A, V_{CE} = -3.0 V		h_{FE}	1,500 1,250 300	18,000	
Collector-Emitter Saturation Voltage I_C = -20 A, I_B = -200 mA I_C = -10 A, I_B = -40 mA		$V_{CE(sat)}$		-3.0 -2.0	V
Base-Emitter Saturation Voltage I_C = -20 A, I_B = -200 mA		$V_{BE(sat)}$		-4.0	V
Base-Emitter Voltage Non-saturated V_{CE} = -3.0 V, I_C = -10 A		V_{BE}		-2.8	V
DYNAMIC CHARACTERISTICS					
Common Emitter Small-Signal Short-Circuit Forward Current Transfer Ratio I_C = -10 A, V_{CE} = -3.0 V, f = 1 kHz		h_{fe}	300		
Magnitude of Common Emitter Small-Signal Short-Circuit Forward Current Transfer Ratio I_C = -10 A, V_{CE} = -3.0 V, f = 1 MHz		$\|h_{fe}\|$	8	80	
Output Capacitance V_{CB} = -10 V, I_E = 0, 100 kHz ≤ f ≤ 1 MHz		C_{obo}		400	pF

ELECTRICAL CHARACTERISTICS @ T_C = 25 °C unless otherwise noted. (continued)

SWITCHING CHARACTERISTICS

Turn-On Time V_{CC} = -30 V, I_C = -10 A; I_B= -40 mA	t_{on}		2.0	µs
Turn-Off Time V_{CC} = -30 V, I_C = -10 A; I_{B1}= I_{B2} = -40 mA	t_{off}		10	µs

SAFE OPERATING AREA (See figures 1 and 2 and MIL-STD-750,Test Method 3053)

DC Tests

T_C = +25 °C, t = 1 second, 1 Cycle

Test 1

V_{CE} = -8.75 V, I_C = -20 A

Test 2

V_{CE} = -30 V, I_C = -5.8 A

Test 3

V_{CE} = -80 V, I_C = -100 mA (2N6286)

V_{CE} = -100 V, I_C = -100 mA (2N6287)

SAFE OPERATING AREA

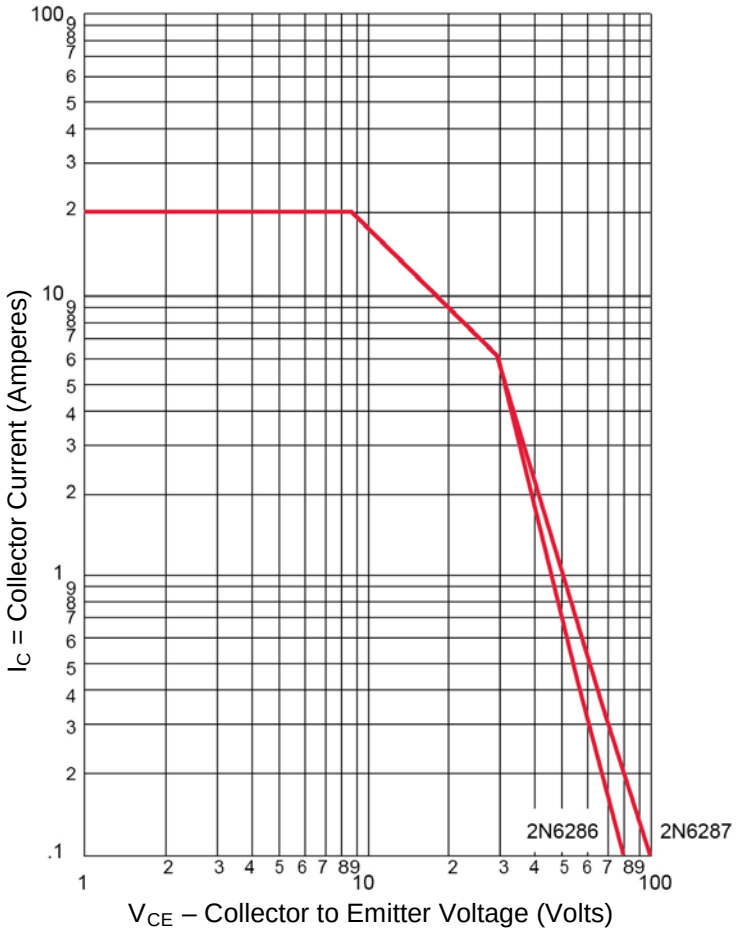


FIGURE 1
Maximum Safe Operating Area Graph
(continuous dc)

SAFE OPERATING AREA (continued)

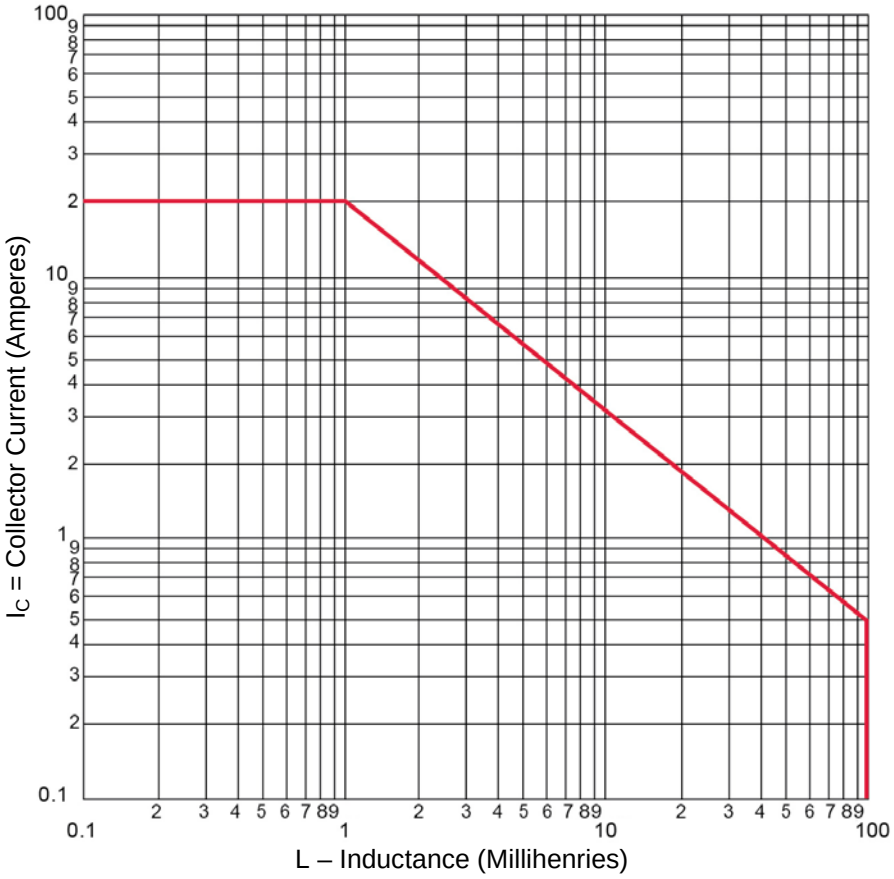
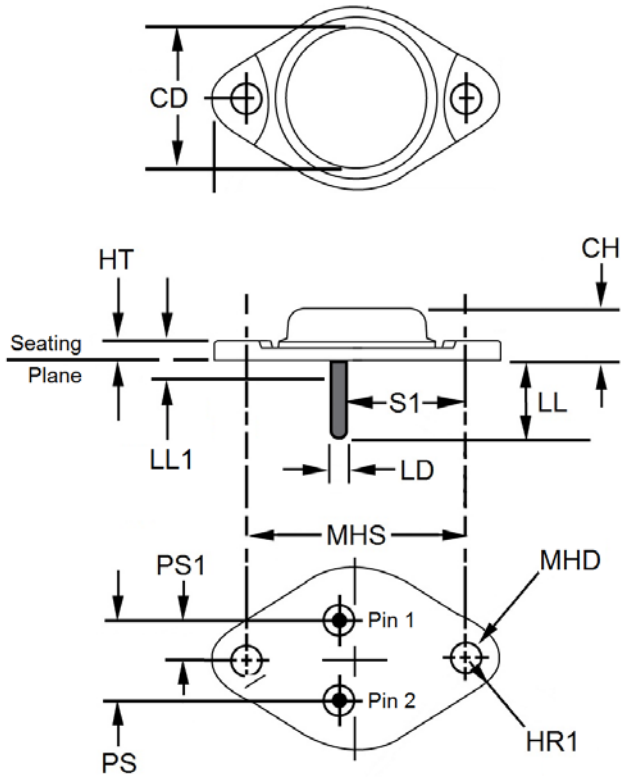


FIGURE 2
Safe Operating Area For Switching Between Saturation And Cutoff
(unclamped inductive load).

PACKAGE DIMENSIONS



Ltr	Dimensions				Notes
	Inches		Millimeters		
	Min	Max	Min	Max	
CD	-	0.875	-	22.23	3
CH	0.250	0.360	6.35	9.14	
HR	0.495	0.525	12.57	13.34	
HR1	0.131	0.188	3.33	4.78	
HT	0.060	0.135	1.52	3.43	
LD	0.038	0.043	0.97	1.09	4, 8
LL	0.312	0.500	7.92	12.70	4
LL1	-	0.050	-	1.27	4, 8
MHD	0.151	0.165	3.84	4.19	6
MHS	1.177	1.197	29.90	30.40	
PS	0.420	0.440	10.67	11.18	3
PS1	0.205	0.225	5.21	5.72	
S1	0.655	0.675	16.64	17.15	
T1	Emitter				
T2	Base				
Case	Collector				

NOTES:

1. Dimensions are in inches. Millimeters are given for information only.
2. Body contour is optional within zone defined by CD
3. These dimensions shall be measured at points 0.050 inch (1.27 mm) to 0.055 inch (1.40 mm) below seating plane.
4. Both terminals
5. At both ends
6. Two holes
7. Terminal 1 is the emitter, terminal 2 is base. The collector shall be electrically connected to the case.
8. LD applies between L1 and LL. Diameter is uncontrolled in L1.
9. In accordance with ASME Y14.5M, diameters are equivalent to Φx symbology.

SCHEMATIC